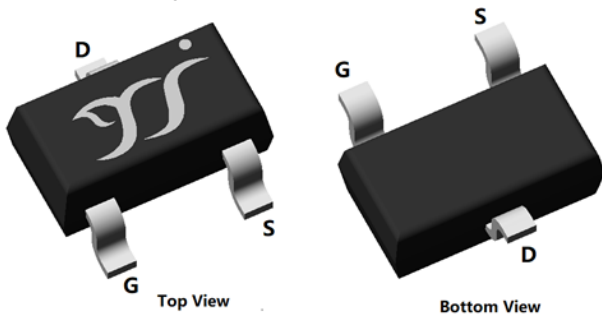
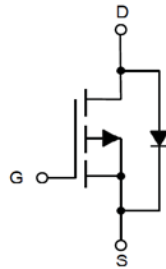


## P-Channel Enhancement Mode Field Effect Transistor



**SOT-23-3L**



### Product Summary

- $V_{DS}$  -30 V
- $I_D$  -7 A
- $R_{DS(ON)}$ ( at  $V_{GS}=-10V$ ) <21 m $\Omega$
- $R_{DS(ON)}$ ( at  $V_{GS}=-4.5V$ ) <28 m $\Omega$

### General Description

- Trench Power LV MOSFET technology
- High density cell design for Low RDS(ON)
- High Speed switching
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Battery protection
- Load switch
- Power management

### ■ Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter                              |                         | Symbol         | Limit    | Unit             |
|--|-------------------------|----------------|----------|------------------|
| Drain-source Voltage                   |                         | $V_{DS}$       | -30      | V                |
| Gate-source Voltage                    |                         | $V_{GS}$       | $\pm 20$ | V                |
| Drain Current                          | $T_A=25^\circ\text{C}$  | $I_D$          | -7       | A                |
|  | $T_A=100^\circ\text{C}$ |                | -4       |                  |
| Pulsed Drain Current <sup>A</sup>      |                         | $I_{DM}$       | -60      | A                |
| Total Power Dissipation <sup>B</sup>   | $T_A=25^\circ\text{C}$  | $P_D$          | 1.2      | W                |
|  | $T_A=100^\circ\text{C}$ |                | 0.5      |                  |
| Junction and Storage Temperature Range |                         | $T_J, T_{STG}$ | -55~+150 | $^\circ\text{C}$ |

### ■ Thermal resistance

| Parameter   |              | Symbol          | Typ | Max | Units              |
|---|--------------|-----------------|-----|-----|--------------------|
| Thermal Resistance Junction-to-Ambient <sup>C</sup> | Steady-State | $R_{\theta JA}$ | 80  | 100 | $^\circ\text{C/W}$ |

### ■ Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| YJL07P03BL    | F2           | 3007B   | 3000                 | 30000                   | 120000                     | 7" reel       |



# YJL07P03BL

## ■ Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

| Parameter                             | Symbol              | Conditions  | Min  | Typ  | Max  | Units |
|---------------------------------------|---------------------|---|------|------|------|-------|
| <b>Static Parameter</b>               |                     |   |      |      |      |       |
| Drain-Source Breakdown Voltage        | BV <sub>DSS</sub>   | V <sub>GS</sub> = 0V, I <sub>D</sub> =-250μA  | -30  | -    | -    | V     |
| Zero Gate Voltage Drain Current       | I <sub>DSS</sub>    | V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V  | -    | -    | -1   | μA    |
|                                       |                     | V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C                           | -    | -    | -100 |       |
| Gate-Body Leakage Current             | I <sub>GSS</sub>    | V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V   | -    | -    | ±100 | nA    |
| Gate Threshold Voltage                | V <sub>GS(th)</sub> | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =-250μA                                  | -1.0 | -1.5 | -2.5 | V     |
| Static Drain-Source On-Resistance     | R <sub>DS(on)</sub> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-7A  | -    | 16   | 21   | mΩ    |
|                                       |                     | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-5A   | -    | 21   | 28   |       |
| Diode Forward Voltage                 | V <sub>SD</sub>     | I <sub>S</sub> =-7A, V <sub>GS</sub> =0V  | -    | -0.9 | -1.2 | V     |
| Gate resistance                       | R <sub>G</sub>      | f=1MHz  | -    | 16   | -    | Ω     |
| Maximum Body-Diode Continuous Current | I <sub>S</sub>      |   | -    | -    | -7   | A     |
| <b>Dynamic Parameters</b>             |                     |   |      |      |      |       |
| Input Capacitance                     | C <sub>iss</sub>    | V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz  | -    | 1220 | -    | pF    |
| Output Capacitance                    | C <sub>oss</sub>    |   | -    | 170  | -    |       |
| Reverse Transfer Capacitance          | C <sub>rss</sub>    |   | -    | 160  | -    |       |
| <b>Switching Parameters</b>           |                     |   |      |      |      |       |
| Total Gate Charge                     | Q <sub>g</sub>      | V <sub>GS</sub> =-10V, V <sub>DS</sub> =-15V, I <sub>D</sub> =-7A                           | -    | 24   | -    | nC    |
| Gate-Source Charge                    | Q <sub>gs</sub>     |   | -    | 2    | -    |       |
| Gate-Drain Charge                     | Q <sub>gd</sub>     |   | -    | 6    | -    |       |
| Reverse Recovery Charge               | Q <sub>rr</sub>     | I <sub>F</sub> =-7A, di/dt=100A/us  | -    | 11   | -    | nC    |
| Reverse Recovery Time                 | t <sub>rr</sub>     |   | -    | 35   | -    | ns    |
| Turn-on Delay Time                    | t <sub>D(on)</sub>  | V <sub>GS</sub> =-10V, V <sub>DD</sub> =-15V, I <sub>D</sub> =-7A<br>R <sub>GEN</sub> =2.5Ω | -    | 11   | -    | ns    |
| Turn-on Rise Time                     | t <sub>r</sub>      |   | -    | 4    | -    |       |
| Turn-off Delay Time                   | t <sub>D(off)</sub> |   | -    | 70   | -    |       |
| Turn-off fall Time                    | t <sub>f</sub>      |   | -    | 50   | -    |       |

A. Repetitive rating; pulse width limited by max. junction temperature.

B. P<sub>d</sub> is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.

C. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in the still air environment with T<sub>A</sub> =25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.



## Typical Electrical and Thermal Characteristics Diagrams

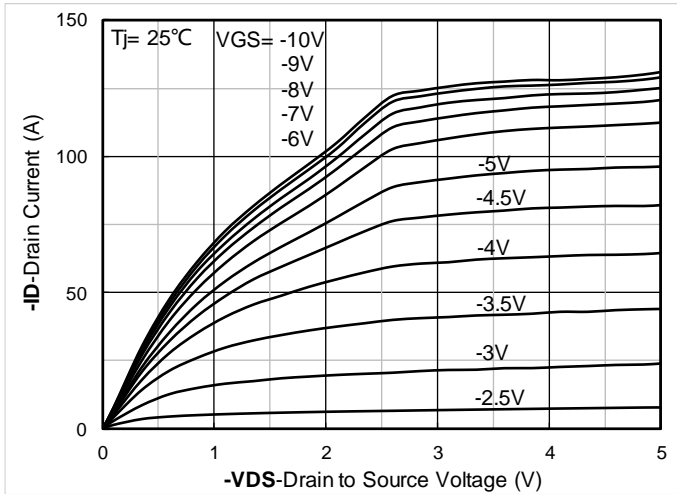


Figure 1. Output Characteristics

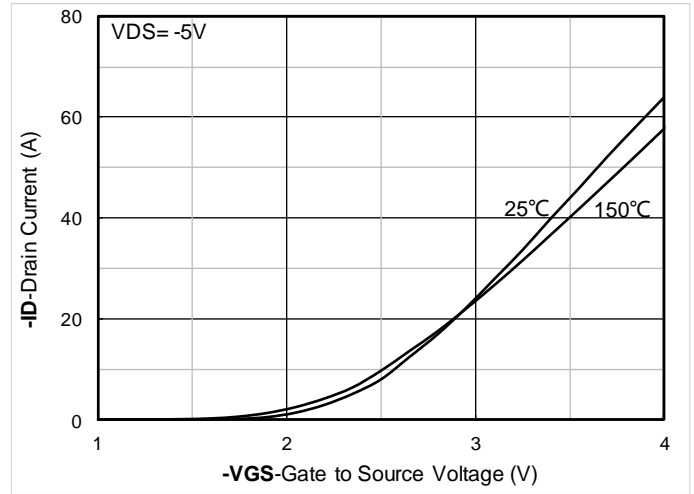


Figure 2. Transfer Characteristics

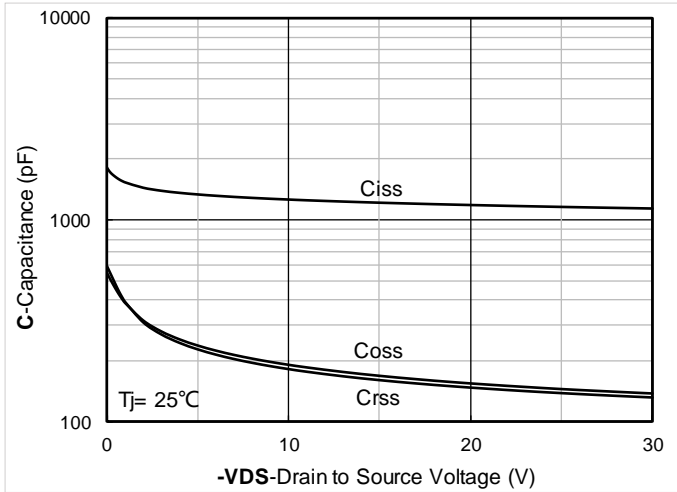


Figure 3. Capacitance Characteristics

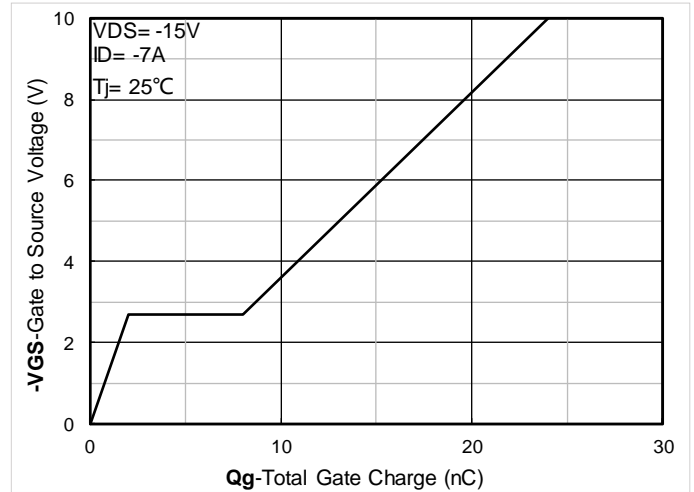


Figure 4. Gate Charge

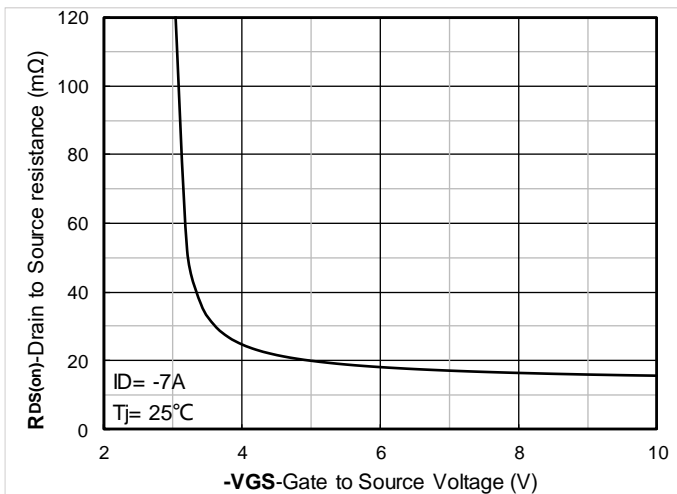


Figure 5. On-Resistance vs Gate to Source Voltage

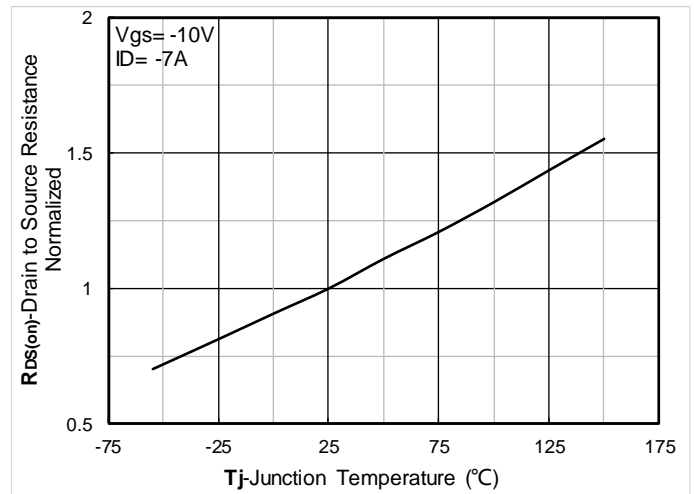


Figure 6. Normalized On-Resistance

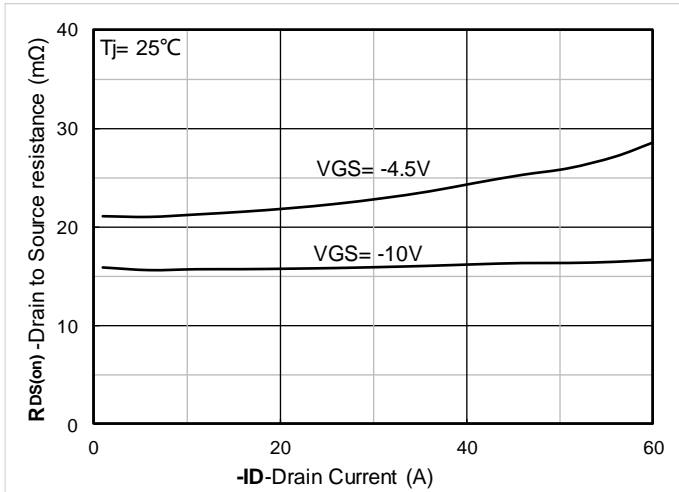


Figure 7.  $R_{DS(on)}$  VS Drain Current

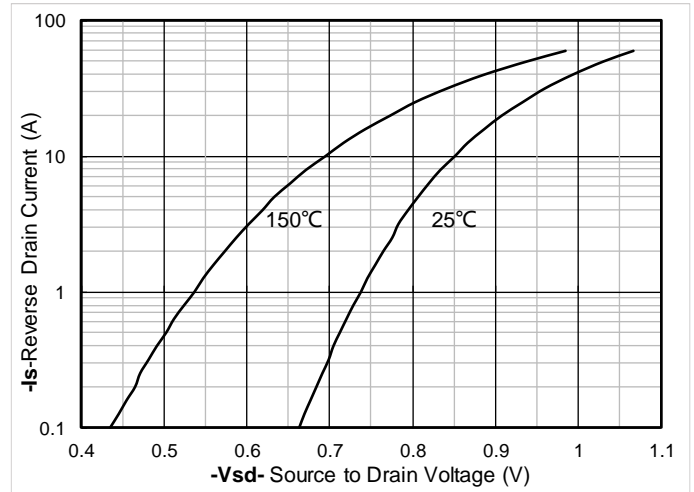


Figure 8. Forward characteristics of reverse diode

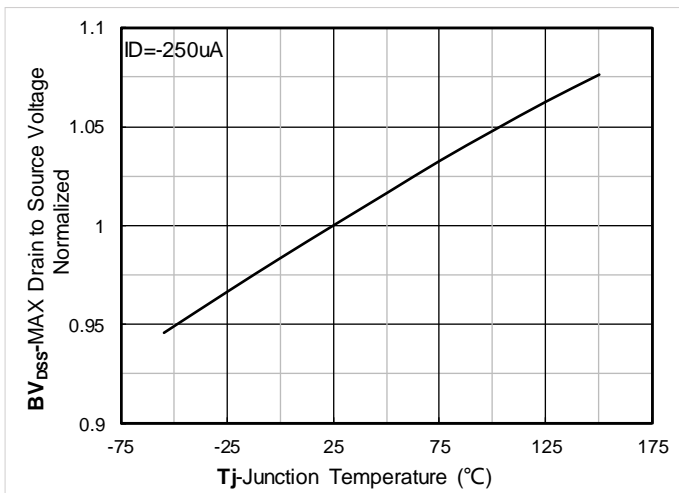


Figure 9. Normalized breakdown voltage

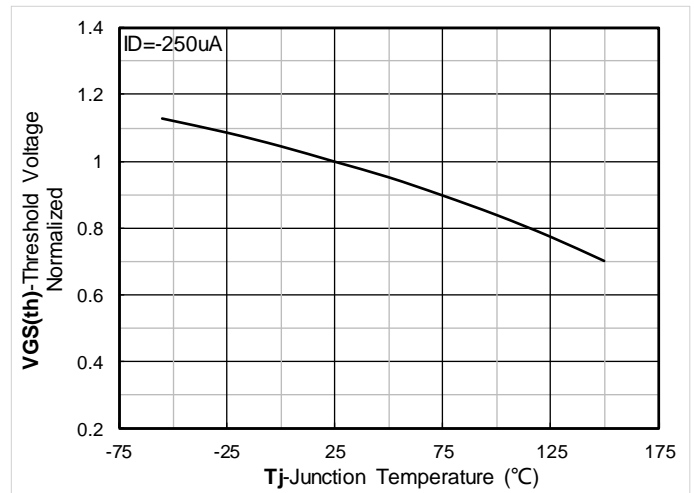


Figure 10. Normalized Threshold voltage

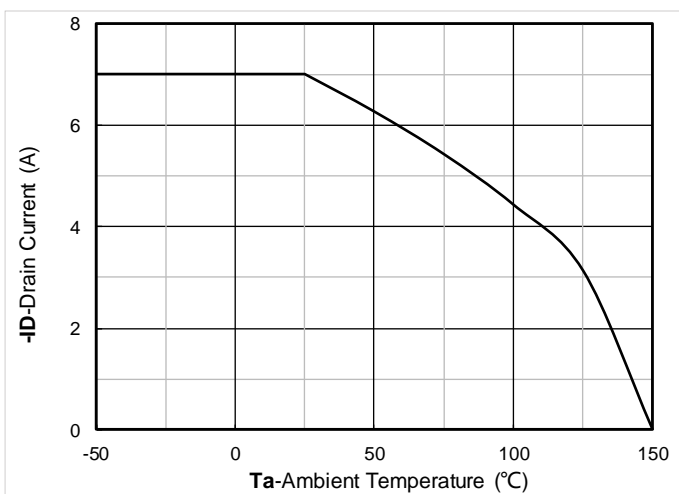


Figure 11. Current dissipation

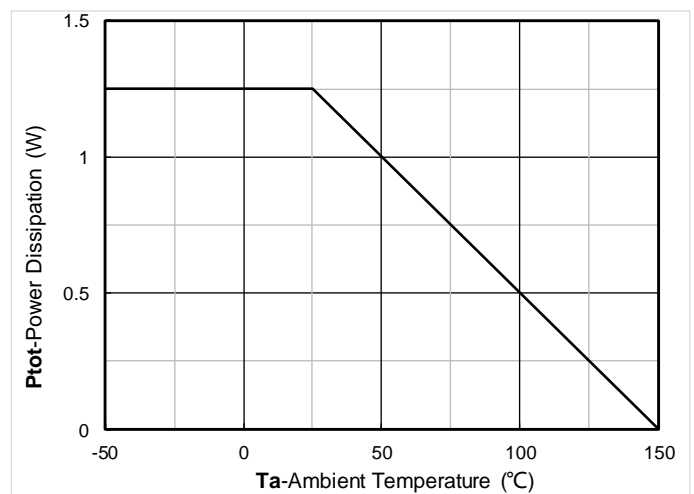


Figure 12. Power dissipation



# YJL07P03BL

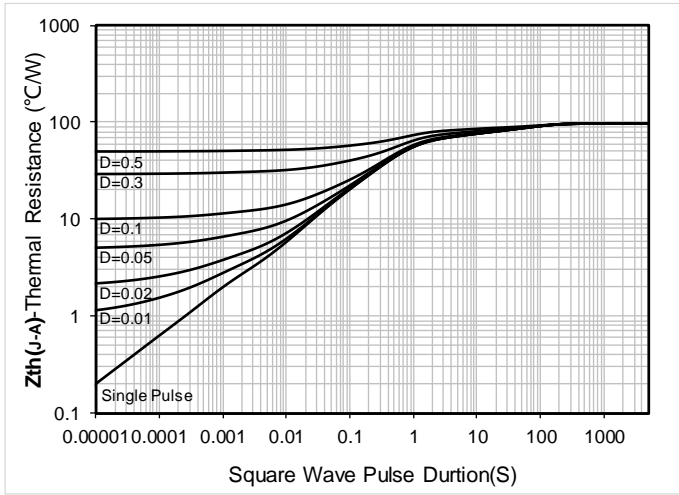


Figure 13. Maximum Transient Thermal Impedance

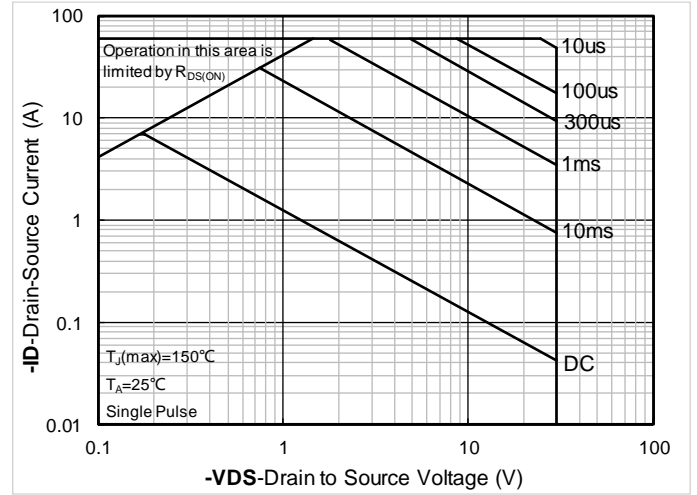
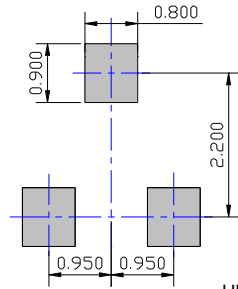
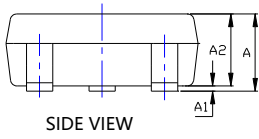
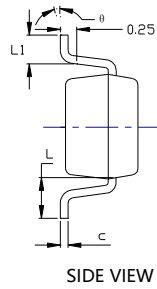
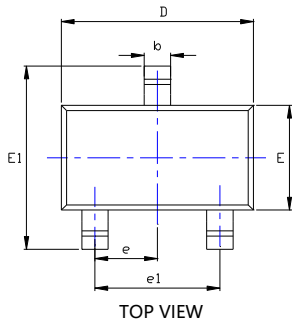


Figure 14. Safe Operation Area

## ■ SOT-23-3L Package information



UNIT: mm

| SYMBOL | DIMENSIONS |       |       |            |       |       |
|--------|------------|-------|-------|------------|-------|-------|
|        | INCHES     |       |       | Millimeter |       |       |
|        | MIN.       | NOM.  | MAX.  | MIN.       | NOM.  | MAX.  |
| A      | 0.041      | ---   | 0.049 | 1.050      | ---   | 1.250 |
| A1     | 0.000      | ---   | 0.008 | 0.000      | ---   | 0.200 |
| A2     | 0.041      | 0.043 | 0.045 | 1.050      | 1.100 | 1.150 |
| b      | 0.012      | 0.016 | 0.020 | 0.300      | 0.400 | 0.500 |
| c      | 0.004      | ---   | 0.008 | 0.100      | ---   | 0.200 |
| D      | 0.111      | 0.115 | 0.119 | 2.820      | 2.920 | 3.020 |
| E      | 0.059      | 0.063 | 0.067 | 1.500      | 1.600 | 1.700 |
| E1     | 0.104      | 0.110 | 0.116 | 2.650      | 2.800 | 2.950 |
| e      | 0.037TYP   |       |       | 0.950TYP   |       |       |
| e1     | 0.071      | 0.075 | 0.079 | 1.800      | 1.900 | 2.000 |
| L      | 0.024REF   |       |       | 0.600REF   |       |       |
| L1     | 0.012      | 0.018 | 0.024 | 0.300      | 0.450 | 0.600 |
| θ      | 0°         | ---   | 8°    | 0°         | ---   | 8°    |

**NOTE:**

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



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